



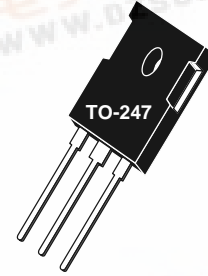
# APT30M85BVFR

300V 40A 0.085Ω

**POWER MOS V<sup>®</sup>**

**FREDFET**

Power MOS V<sup>®</sup> is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V<sup>®</sup> also achieves faster switching speeds through optimized gate layout.



- Fast Recovery Body Diode
- Lower Leakage
- Faster Switching
- 100% Avalanche Tested
- Popular TO-247 Package

**MAXIMUM RATINGS**

All Ratings: T<sub>C</sub> = 25°C unless otherwise specified.

Symbol	Parameter	APT30M85BVFR	UNIT
V <sub>DSS</sub>	Drain-Source Voltage	300	Volts
I <sub>D</sub>	Continuous Drain Current @ T <sub>C</sub> = 25°C	40	Amps
I <sub>DM</sub>	Pulsed Drain Current <sup>①</sup>	160	
V <sub>GS</sub>	Gate-Source Voltage Continuous	±30	Volts
V <sub>GSM</sub>	Gate-Source Voltage Transient	±40	
P <sub>D</sub>	Total Power Dissipation @ T <sub>C</sub> = 25°C	300	Watts
	Linear Derating Factor	2.4	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C
T <sub>L</sub>	Lead Temperature: 0.063" from Case for 10 Sec.	300	
I <sub>AR</sub>	Avalanche Current <sup>①</sup> (Repetitive and Non-Repetitive)	40	Amps
E <sub>AR</sub>	Repetitive Avalanche Energy <sup>①</sup>	30	mJ
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>④</sup>	1300	

**STATIC ELECTRICAL CHARACTERISTICS**

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA)	300			Volts
I <sub>D(on)</sub>	On State Drain Current <sup>②</sup> (V <sub>DS</sub> > I <sub>D(on)</sub> × R <sub>DS(on)</sub> Max, V <sub>GS</sub> = 10V)	40			Amps
R <sub>DS(on)</sub>	Drain-Source On-State Resistance <sup>②</sup> (V <sub>GS</sub> = 10V, 0.5 I <sub>D[Cont.]</sub> )			0.085	Ohms
I <sub>bSS</sub>	Zero Gate Voltage Drain Current (V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V)			250	μA
	Zero Gate Voltage Drain Current (V <sub>DS</sub> = 0.8 V <sub>DSS</sub> , V <sub>GS</sub> = 0V, T <sub>C</sub> = 125°C)			1000	
I <sub>GSS</sub>	Gate-Source Leakage Current (V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V)			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage (V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1.0mA)	2		4	Volts

**CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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**DYNAMIC CHARACTERISTICS**

**APT30M85BVFR**

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V V <sub>DS</sub> = 25V f = 1 MHz		4100	4950	pF
C <sub>oss</sub>	Output Capacitance			700	980	
C <sub>rss</sub>	Reverse Transfer Capacitance			200	300	
Q <sub>g</sub>	Total Gate Charge ③	V <sub>GS</sub> = 10V V <sub>DD</sub> = 0.5 V <sub>DSS</sub> I <sub>D</sub> = I <sub>D</sub> [Cont.] @ 25°C		130	195	nC
Q <sub>gs</sub>	Gate-Source Charge			25	37	
Q <sub>gd</sub>	Gate-Drain ("Miller") Charge			55	77	
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> = 15V V <sub>DD</sub> = 0.5 V <sub>DSS</sub> I <sub>D</sub> = I <sub>D</sub> [Cont.] @ 25°C R <sub>G</sub> = 1.6Ω		12	24	ns
t <sub>r</sub>	Rise Time			10	20	
t <sub>d(off)</sub>	Turn-off Delay Time			43	35	
t <sub>f</sub>	Fall Time			7	14	

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I <sub>S</sub>	Continuous Source Current (Body Diode)			40	Amps
I <sub>SM</sub>	Pulsed Source Current ① (Body Diode)			160	
V <sub>SD</sub>	Diode Forward Voltage ② (V <sub>GS</sub> = 0V, I <sub>S</sub> = -I <sub>D</sub> [Cont.])			1.3	Volts
dv/dt	Peak Diode Recovery dv/dt ⑤			5	V/ns
t <sub>rr</sub>	Reverse Recovery Time (I <sub>S</sub> = -I <sub>D</sub> [Cont.], di/dt = 100A/μs)	T <sub>j</sub> = 25°C		200	ns
		T <sub>j</sub> = 125°C		400	
Q <sub>rr</sub>	Reverse Recovery Charge (I <sub>S</sub> = -I <sub>D</sub> [Cont.], di/dt = 100A/μs)	T <sub>j</sub> = 25°C	0.8		μC
		T <sub>j</sub> = 125°C	3.8		
I <sub>RRM</sub>	Peak Recovery Current (I <sub>S</sub> = -I <sub>D</sub> [Cont.], di/dt = 100A/μs)	T <sub>j</sub> = 25°C	10		Amps
		T <sub>j</sub> = 125°C	23		

**THERMAL CHARACTERISTICS**

Symbol	Characteristic	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>	Junction to Case			0.42	°C/W
R <sub>θJA</sub>	Junction to Ambient			40	

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting T<sub>j</sub> = +25°C, L = 1.63mH, R<sub>G</sub> = 25Ω, Peak I<sub>L</sub> = 40A

⑤ I<sub>S</sub> ≤ -I<sub>D</sub> [Cont.], di/dt = 100A/μs, V<sub>DD</sub> ≤ V<sub>DSS</sub>, T<sub>j</sub> ≤ 150°C, R<sub>G</sub> = 2.0Ω, V<sub>R</sub> = 200V.

APT Reserves the right to change, without notice, the specifications and information contained herein.

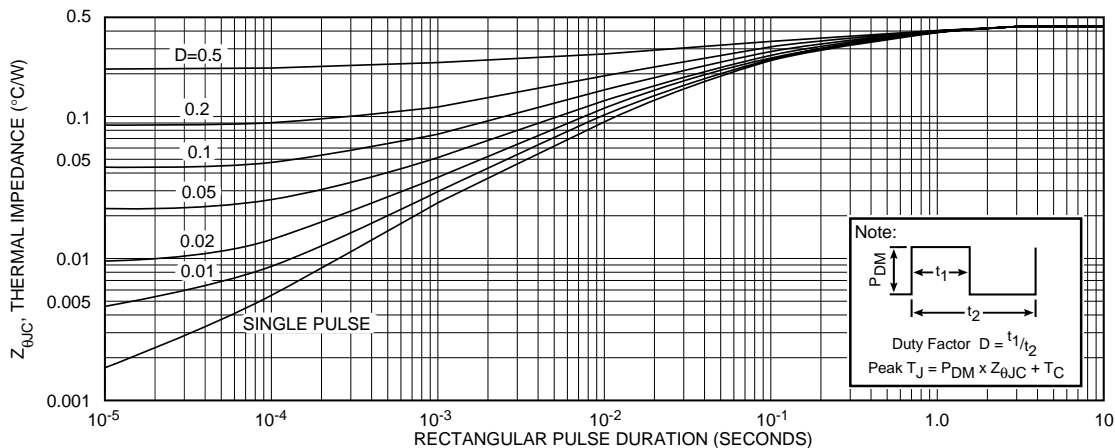
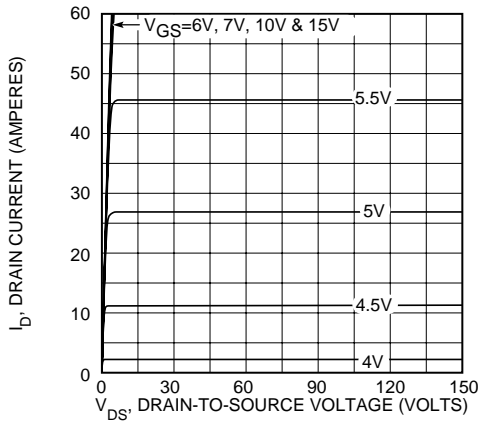
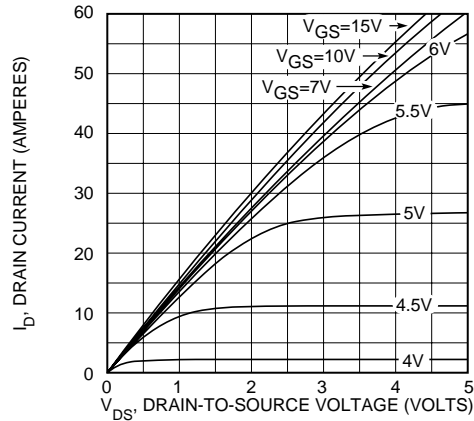


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

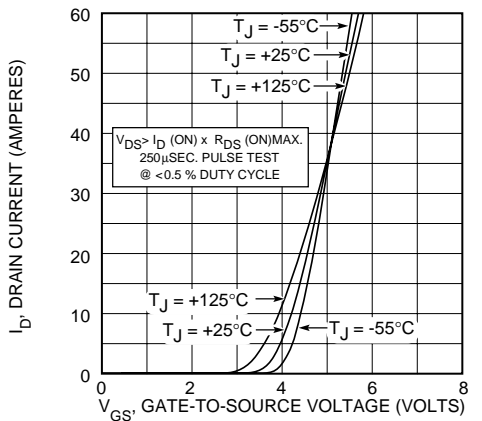
**APT30M85BVF**



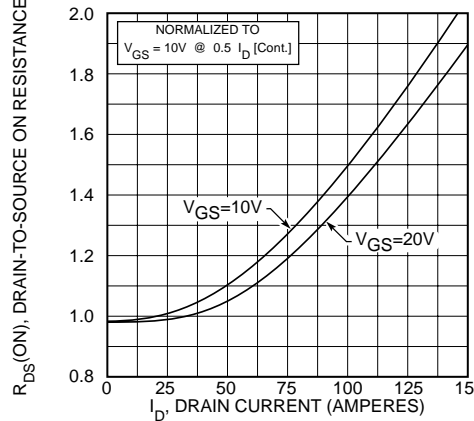
**FIGURE 2, TYPICAL OUTPUT CHARACTERISTICS**



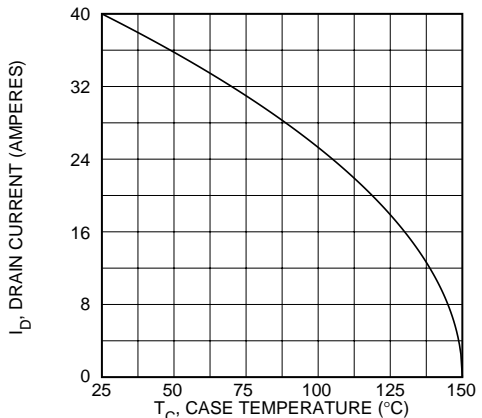
**FIGURE 3, TYPICAL OUTPUT CHARACTERISTICS**



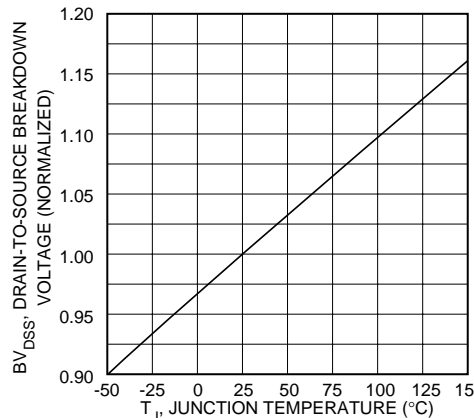
**FIGURE 4, TYPICAL TRANSFER CHARACTERISTICS**



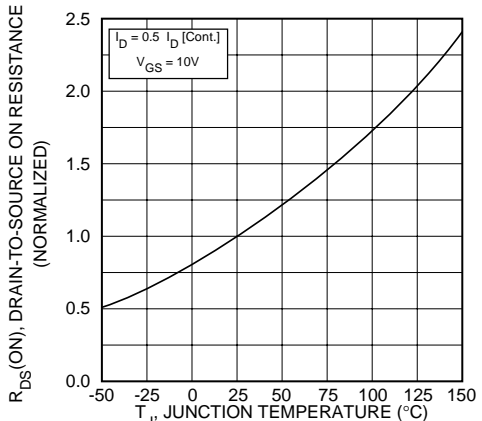
**FIGURE 5,  $R_{DS(ON)}$  vs DRAIN CURRENT**



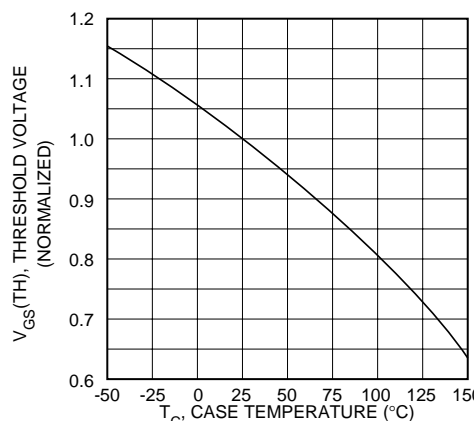
**FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE**



**FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE**

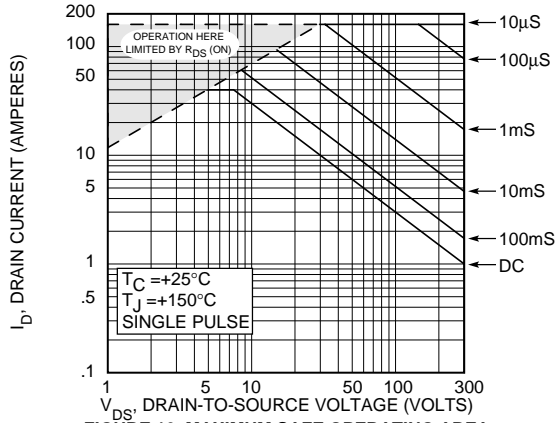


**FIGURE 8, ON-RESISTANCE vs. TEMPERATURE**

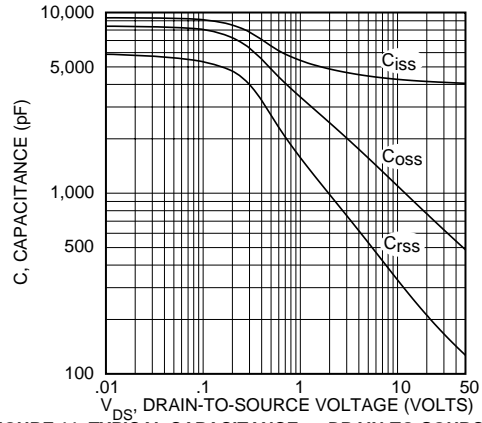


**FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE**

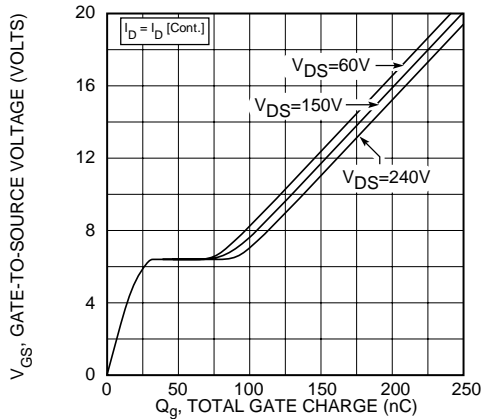
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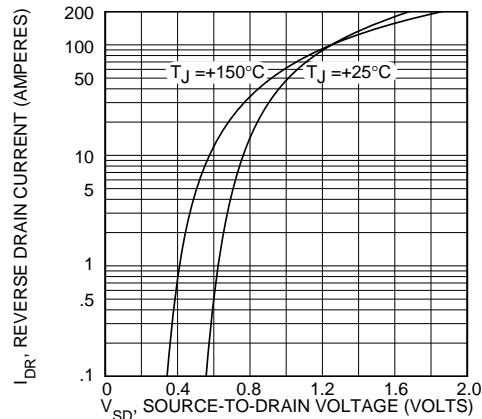
**FIGURE 10, MAXIMUM SAFE OPERATING AREA**



**FIGURE 11, TYPICAL CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE**

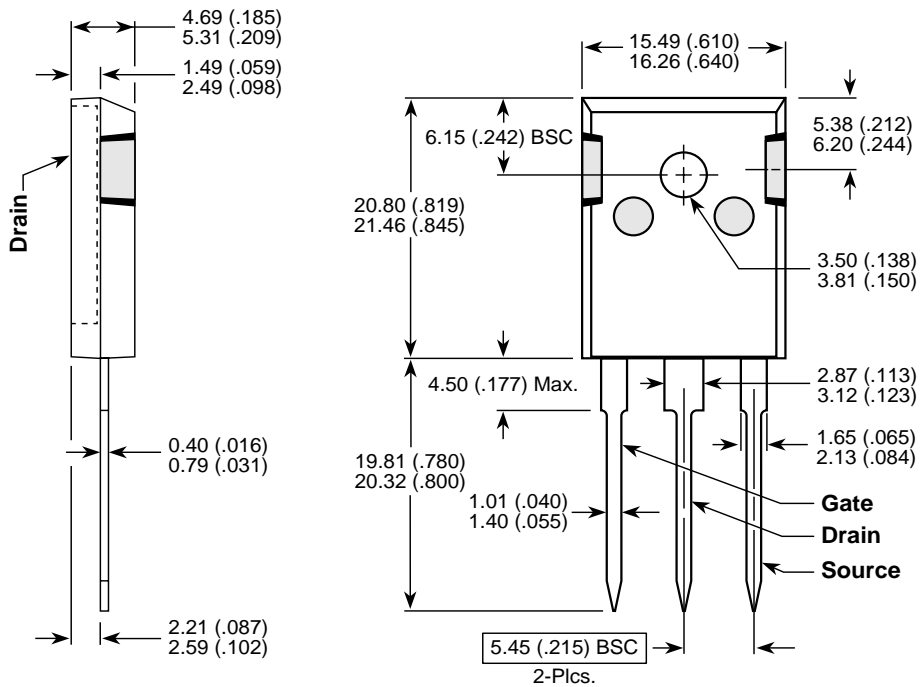


**FIGURE 12, GATE CHARGES vs GATE-TO-SOURCE VOLTAGE**



**FIGURE 13, TYPICAL SOURCE-DRAIN DIODE FORWARD VOLTAGE**

**TO-247 Package Outline**



Dimensions in Millimeters and (Inches)